

70V 15mA Schottky Diode – 1N5711

Small-signal ultra-fast switching schottky diode in bare die form

Rev 1.0 01/02/19

Features:

- Picosecond switching speed
- Low forward voltage drop
- 70V breakdown voltage
- Guard-Ring for over-voltage protection
- High reliability tested grades & matched characteristic options.

Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-750 /2073 Visual Inspection
- "H" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

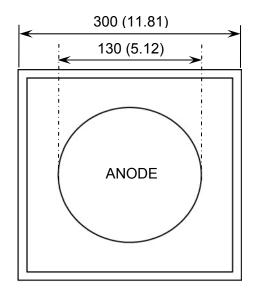
For further information on LAT process flows see below.

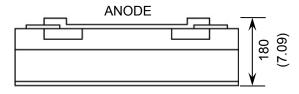
www.siliconsupplies.com\quality\bare-die-lot-qualification

Supply Formats:

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- Die Thickness <> 180µm(7 Mils) On request
- With additional electrical selection On request

Die Dimensions in µm (mils)





CHIP BACKSIDE IS CATHODE

Mechanical Specification

Die Size (with scribe line)	350 x 350 11.81 x 11.81	µm mils	
Anode Pad Size	130 Ø 5.1 Ø	μm mils	
Die Thickness	180 (±15) 7.09 (±0.59)	μm mils	
Top Metal Composition	Al		
Back Metal Composition	AuAs		





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Absolute Maximum Ratings¹ T_J = 25°C unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT
Repetitive Peak Reverse Voltage	V _{RRM}	70	V
Repetitive Peak Working Voltage	V _{RWM}	70	V
DC Blocking Voltage	V _R	70	V
DC Forward Current	I _F	15	mA
Non-repetitive Peak forward surge current ²	I _{FSM}	100	mA
Power Dissipation	P _D	400	mW
Operating Junction temperature	TJ	-65 to 150	°C
Storage Temperature Range	T _{STG}	-65 to 200	°C

Electrical Characteristics T_J = 25°C unless otherwise stated

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Breakdown Voltage ³	V_{BR}	I _R = 10μA	70	-	-	V
Forward Voltage ³	V _F	I _F = 1mA	-	-	0.41	V
		I _F = 15mA	-	-	1	
Reverse Leakage ³	I _R	V _R = 50V	-	-	200	nA
Junction Capacitance	CJ	$V_R = 0V$, $f = 1MHz$	-	-	2	pF
Reverse Recovery Time	t _{rr}	$I_F = I_R = 5mA,$ $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$	-	-	1	ns

^{1.} Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability. 2. 8.3ms single half sine-wave. 3. Pulse test; tp≤300 µs

Typical Characteristics T_J = 25°C unless otherwise stated

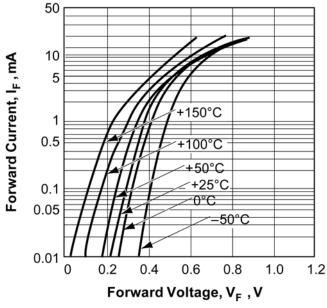


FIGURE 1. Forward Voltage Characteristics

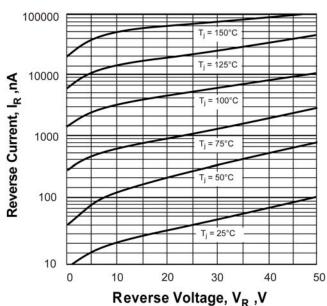


FIGURE 2. Reverse Current Versus Reverse Voltage





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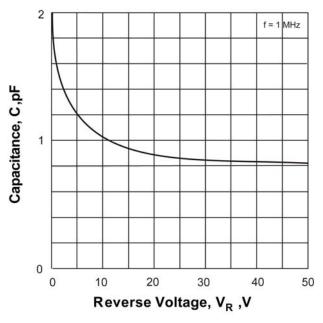


FIGURE 3. Junction Capacitance Versus Reverse Voltage

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